

# Jida Zhang

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## EDUCATION

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<b>Stanford University, Graduate</b> <i>Ph.D.</i> , Electrical Engineering	2024 – Present GPA: 4.3/4
<b>Tsinghua University, Undergraduate</b> <i>B.Eng.</i> , Electronic Information Science and Technology	2020 – 2024 GPA: 3.95/4

## PUBLICATIONS

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- ◇ **IEEE Communications Letters**  
Wideband Active RISs: Architecture, Modeling, and Beamforming Design  
**Jida Zhang**, Zhiyi Li and Zijian Zhang
- ◇ **IWCMC 23**  
Enhancing Energy Efficiency for Reconfigurable Intelligent Surfaces with Practical Power Models  
Zhiyi Li, **Jida Zhang**, Jieao Zhu, Shi Jin and Linglong Dai

## EXPERIENCE

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- ◇ **Research Assistant, Stanford** 2025.1 – Present  
Advisor: Prof. Zerina Kapetanovic; Collaborator: Geneva Ecola  
Currently working on enabling wireless communication with modulated Johnson noise
- ◇ **Research Assistant, Stanford** 2024.9 – 2024.12  
Advisor: Prof. Amin Arbabian; Collaborator: Shubo Yang  
Millimeter-wave wireless sensing
- ◇ **Research Intern, UIUC** 2023.6 – 2024.6  
Advisor: Prof. Deepak Vasisht; Collaborator: Ishani Janveja  
Space Spectrum Awareness
- ◇ **Research Assistant, Tsinghua** 2024.1 – 2024.6  
Advisor: Prof. Yuan Shen  
Undergraduate thesis: localization
- ◇ **Research Assistant, Tsinghua** 2022.1 – 2023.6  
Advisor: Prof. Linglong Dai; Collaborator: Zijian Zhang  
Optimization for reconfigurable intelligent surface aided wireless communications

## HONORS & AWARDS

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- ◇ The Enlight Foundation Graduate Fellowship 2024
- ◇ Excellent Graduates of Tsinghua University & Beijing 2024
- ◇ Comprehensive Excellence Scholarship 2023
- ◇ First Prize in Beijing Challenge Cup Academic Competition 2023
- ◇ Five-Star (Highest Honor) Volunteer of Tsinghua University 2023
- ◇ Academic Excellence Scholarship 2021 & 2022